Silicon Planar Zener Diode for Surge Absorb

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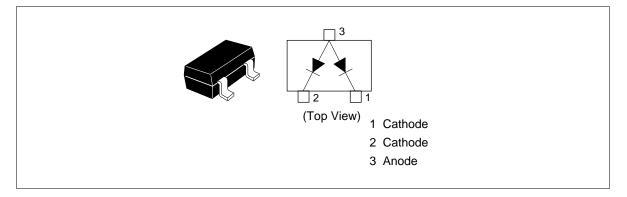
Features

- HZM6.8ZMWA has two devices in a monolithic, and can absorb surge.
- Low capacitance (C=25pF max) and can protect ESD of signal line.
- MPAK Package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Туре No.	Laser Mark	Package Code
HZM6.8ZMWA	68N	МРАК

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Value	Unit	
Power dissipation	Pd ^{*1}	200	mW	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note 1. Four device total, See Fig.2.

Electrical Characteristics $(Ta = 25^{\circ}C)^{*1}$

Item	Symbol	Min	Тур	Мах	Unit	Test Condition
Zener voltage	Vz	6.47	_	7.00	V	$I_z = 5 \text{ mA}, 40 \text{ms} \text{ pulse}$
Reverse current	I _R	—	—	2	μΑ	$V_R = 3.5V$
Capacitance	С		_	25	pF	$V_{R} = 0V$, f = 1 MHz
Dynamic resistance	r _d	_	_	30	Ω	$I_z = 5 \text{ mA}$
ESD-Capability *2Å@*3	—	20	_	—	kV	C =150pF, R = 330Ω , Both forward and reverse direction 10 pulse

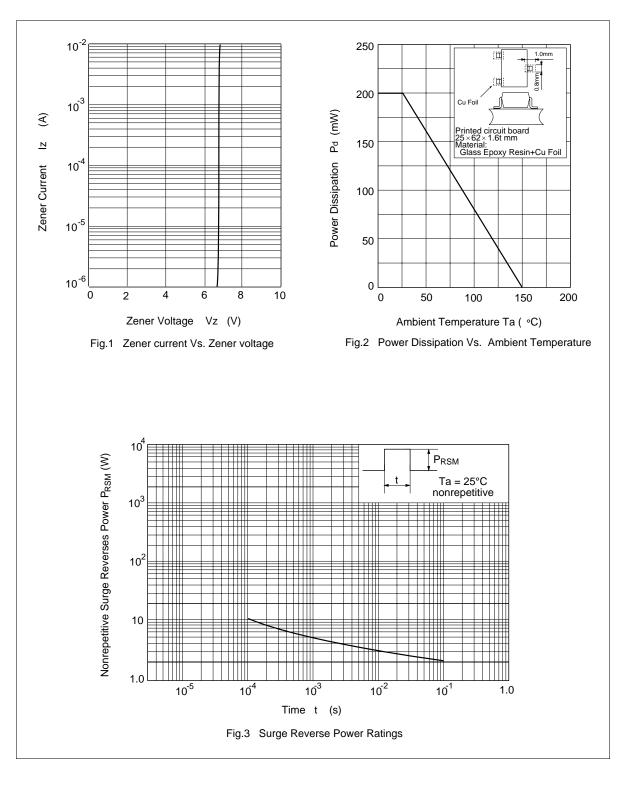
Notes 1. Per one device.

2. Failure criterion ; IR>2 μ A at VR = 3.5V.

3. Between cathode and anode.

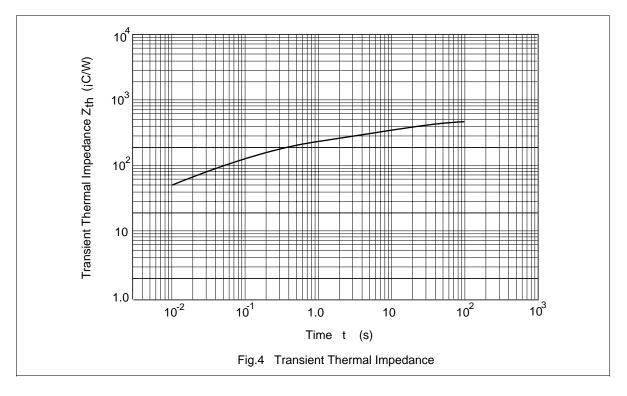
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Main Characteristic



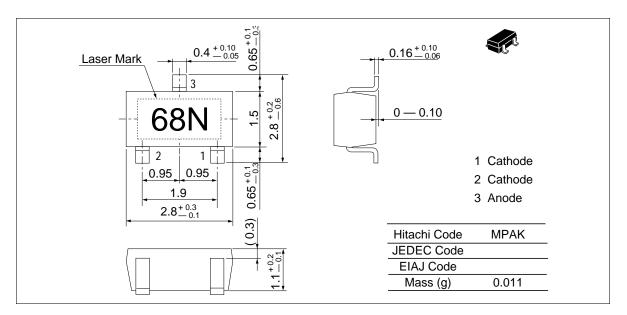
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Main Characteristic



Package Dimensions

Unit : mm



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Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109 URL NorthAmerica http:semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg Europe http://www.has.hitachi.com.sg/grp3/sicd/index.htm http://www.hitachi.com.tw/E/Product/SICD_Frame.htm Asia (Singapore) Asia (Taiwan) Asia (HongKong) http://www.hitachi.com.hk/eng/bo/grp3/index.htm http://www.hitachi.co.jp/Sicd/indx.htm Japan For further information write to: Hitachi Semiconductor Hitachi Europe GmbH Hitachi Asia Pte. Ltd. Hitachi Asia (Hong Kong) Ltd. (America) Inc. Electronic components Group 16 Collyer Quay #20-00 179 East Tasman Drive, Dornacher Stra§e 3 Hitachi Tower San Jose,CA 95134 D-85622 Feldkirchen, Munich Singapore 049318 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Germany Tel: 535-2100 Tel: <49> (89) 9 9180-0 Fax: 535-1533 Fax: <49> (89) 9 29 30 00 Hitachi Asia Ltd. Hitachi Europe Ltd. Taipei Branch Office Electronic Components Group. Whitebrook Park 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Lower Cookham Road Tel: <886> (2) 2718-3666 Maidenhead Fax: <886> (2) 2718-8180 Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322

Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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